layer.

depositing a layer of tantalum pentoxide film directly overlaying and attaching to the metal film

Please add new claim 15 as follows:

15. (New)

A method of manufacturing a thin film resistor with a moisture barrier comprising: depositing a metal film layer on a substrate; attaching a termination on each end of the metal film; depositing a passivation layer directly overlaying and attaching to the metal film layer; and depositing a layer of tantalum pentoxide film directly overlaying and attaching to the passivation layer.